



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application

Albert John DZERMEJKO et al

Serial No.: 10/070,738

Examiner: DZERMEJKO et al.

Filed: August 16, 2002

Art Unit: 1742

For: COOLING PANEL FOR A SHAFT FURNACE, SHAFT FURNACE PROVIDED WITH COOLING PANELS OF THIS NATURE, AND A PROCESS FOR PRODUCING SUCH A COOLING PANEL

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Pursuant to Rules 56 and 98, Applicants hereby call the attention of the Patent Office to the references listed on the attached Form PTO 1449.

Applicants present these references so that the Patent Office may, in the first instance, determine any relevancy thereof to the presently claimed invention, see Beckman Instruments, Inc. v. Chemtronics, Inc., 439 F.2d 1369, 1380, 165 USPQ 355, 364 (5th Cir. 1970). Also see Patent Office Rule 104. Applicants respectfully request that these references be expressly considered during the prosecution of this application and made of record herein and appear among the "References Cited" on any patent to issue herefrom.

Respectfully submitted,

Date: Sept. 20, 2004

By:

APV/pgw  
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SEP 20 2004

SHEET 1 OF 1

FORM PTO-1449 U.S. Department of Commerce  
(Rev. 4/92) Patent and Trademark Office

ATTY. DOCKET NO.  
APV31549

SERIAL NO.  
10/070.738

## INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

APPLICANT  
DZERMEJKO et al.

FILING DATE  
August 16, 2002

GROUP  
1742

## **U.S. PATENT DOCUMENTS**

## **FOREIGN PATENT DOCUMENTS**

**OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)**


**EXAMINER**

**DATE CONSIDERED**

**EXAMINER:** Initial if citation is considered, draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.